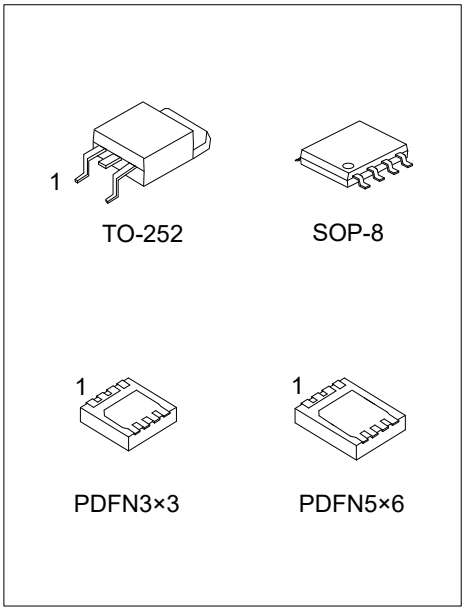
UT7422

Power MOSFET

40A, 30V N-CHANNEL POWER MOSFET



■ DESCRIPTION

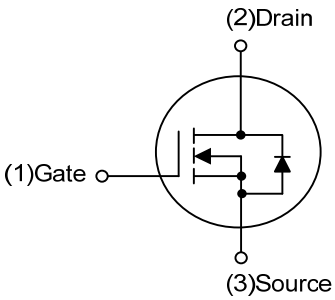
The UTC **UT7422** is a N-channel Power Mosfet, it uses UTC's advanced technology to provide the customers with a minimum on state resistance, etc.

The UTC **UT7422** is suitable for load switch and battery protection applications.

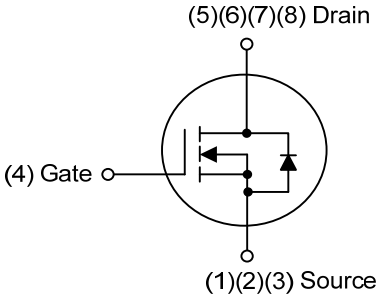
■ FEATURES

* $R_{DS(ON)} \leq 5.6\ m\Omega$ @ V_{GS}=10V, I_D=20A
  $R_{DS(ON)} \leq 9.6\ m\Omega$ @ V_{GS}=4.5V, I_D=16A
* Low $R_{DS(ON)}$

■ SYMBOL



TO-252



SOP-8/PDFN3×3/PDFN5×6

■ ORDERING INFORMATION

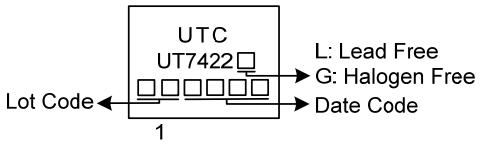
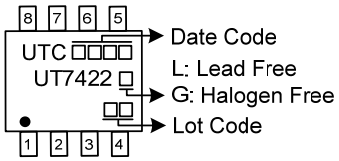
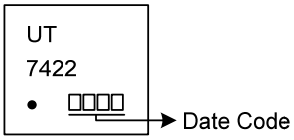
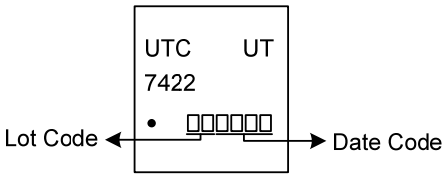
Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UT7422L-TN3-R	UT7422G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
UT7422L-S08-R	UT7422G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel
UT7422L-P3030-R	UT7422G-P3030-R	PDFN3×3	S	S	S	G	D	D	D	D	Tape Reel
UT7422L-P5060-R	UT7422G-P5060-R	PDFN5×6	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

UT7422G-TN3-R
(1)Packing Type
(2)Package Type
(3)Green Package

(1) R: Tape Reel
(2) TN3: TO-252, S08: SOP-8, P3030: PDFN3×3
P5060: PDFN5×6
(3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING

TO-252	SOP-8
	
PDFN3×3	**PDFN5×6**
	

■ ABSOLUTE MAXIMUM RATINGS (T_A=25°C, unless otherwise noted)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage			V_{DSS}	30	V
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current			I_D	40	A
Pulsed Drain Current (Note 2)			I_{DM}	160	A
Avalanche Energy L=0.1mH (Note 3)			E_{AS}	48	mJ
Power Dissipation	T_C=25°C	TO-252	P_D	46	W
		SOP-8		1.8	W
		PDFN3×3		28	W
		PDFN5×6		30	W
Junction Temperature			T_J	-55 ~ +150	°C
Storage Temperature Range			T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Pulse width limited by maximum junction temperature
3. L = 0.1mH, I_{AS} = 31A, V_{DD} = 20V, R_G = 25Ω, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-252	θ_{JA}	50	°C/W
	SOP-8		90	°C/W
	PDFN3×3		60	°C/W
	PDFN5×6		65	°C/W
Junction to Case	TO-252	θ_{JC}	2.7	°C/W
	SOP-8		69	°C/W
	PDFN3×3		4.46	°C/W
	PDFN5×6		4.16	°C/W

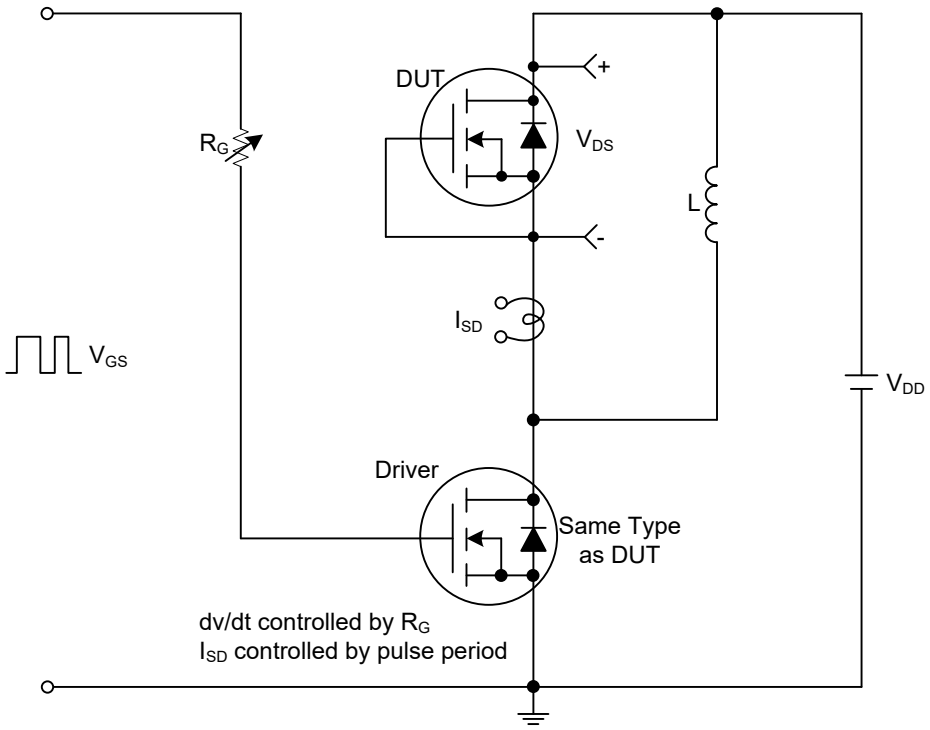
Notes: 1. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
2. The data tested by pulsed, pulse width ≤ 300μs, duty cycle ≤ 2%.

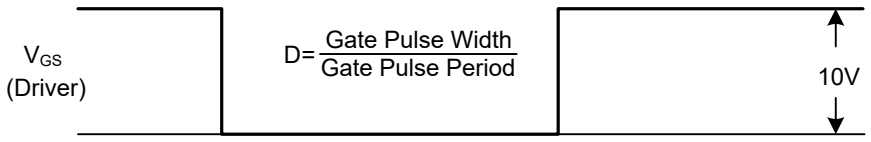
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise noted)

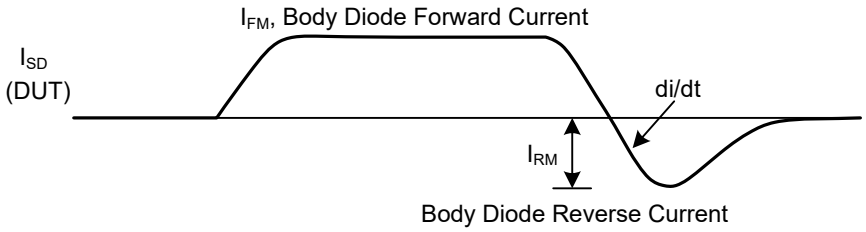
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
STATIC PARAMETERS						
Drain-Source Breakdown Voltage	BV_{DSS}	I_D=250μA, V_{GS}=0V	30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=30V, V_{GS}=0V			1	μA
		V_{DS}=30V, V_{GS}=0V, T_J=55°C			5	μA
Gate-Source Leakage Current	I_{GSS}	V_{GS}=±20V, V_{DS}=0V			100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	1.0		3.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=20A			5.6	mΩ
		V_{GS}=4.5V, I_D=16A			9.6	mΩ
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	V_{GS}=0V, V_{DS}=15V, f=1.0MHz		2140		pF
Output Capacitance	C_{OSS}			490		pF
Reverse Transfer Capacitance	C_{RSS}			425		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q_G	V_{GS}=4.5V, V_{DS}=24V, I_D=40A		33		nC
Gate to Source Charge	Q_{GS}			8		nC
Gate to Drain Charge	Q_{GD}			17		nC
Turn-ON Delay Time	$t_{D(ON)}$	V_{DD}=15V, V_{GS}=4.5V, I_D=40A, R_G=3Ω (Note 1, 2)		19		ns
Rise Time	t_R			26		ns
Turn-OFF Delay Time	$t_{D(OFF)}$			35		ns
Fall-Time	t_F			33		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current (Note)	I_S				40	A
Maximum Body-Diode Pulsed Current	I_{SM}				160	A
Diode Forward Voltage	V_{SD}	I_S=1.0A,V_{GS}=0V			1	V

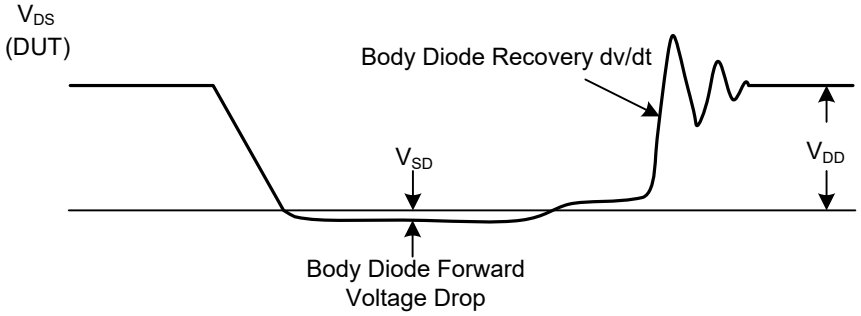
Notes: 1. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



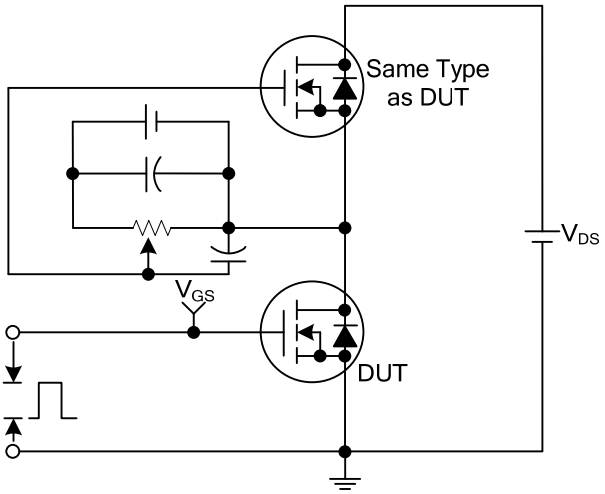




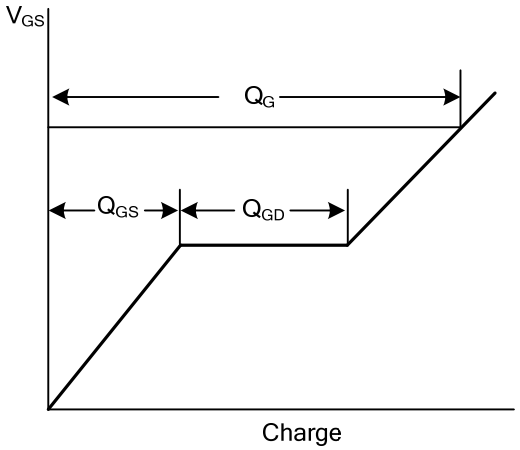


Peak Diode Recovery dv/dt Test Circuit and Waveforms

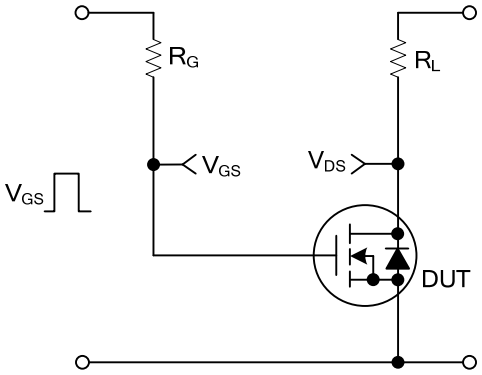
■ TEST CIRCUITS AND WAVEFORMS



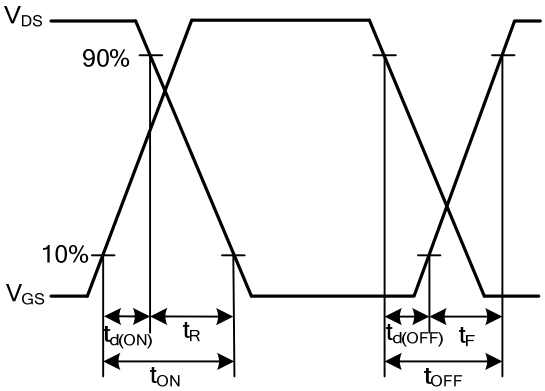
Gate Charge Test Circuit



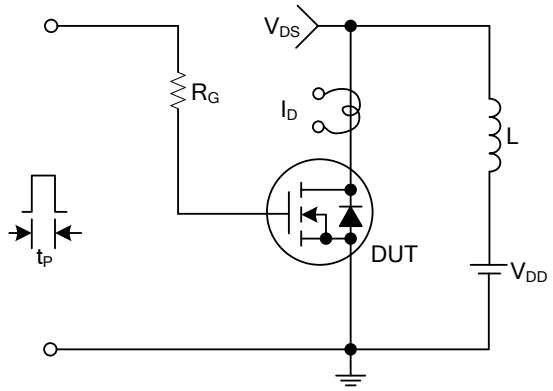
Gate Charge Waveforms



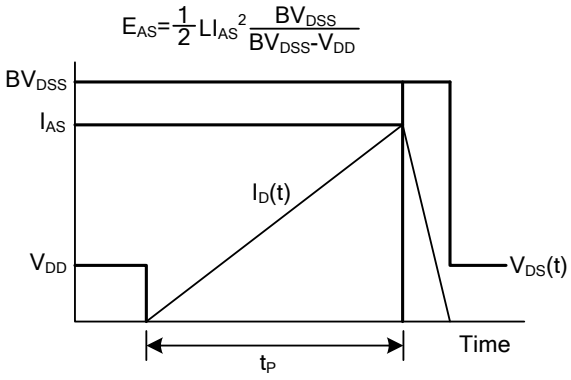
Resistive Switching Test Circuit



Resistive Switching Waveforms



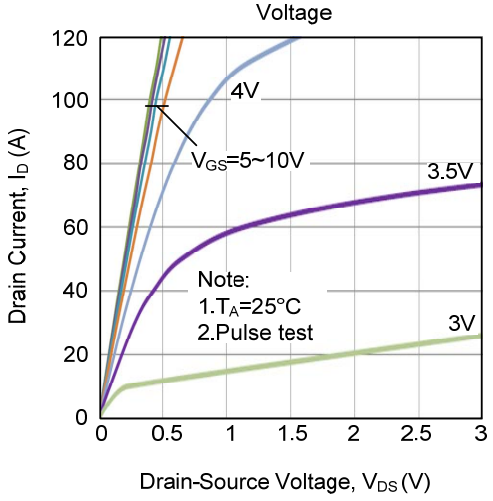
Unclamped Inductive Switching Test Circuit



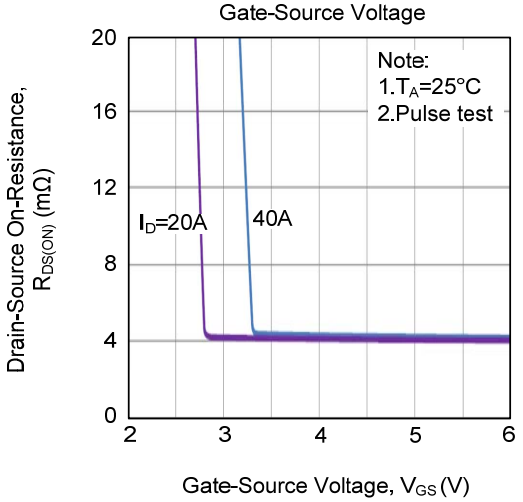
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

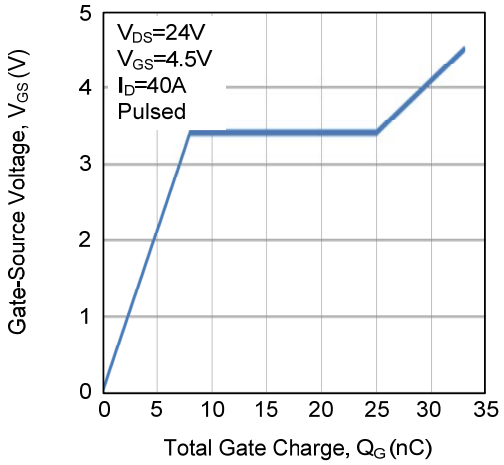
Drain Current vs. Drain-Source Voltage



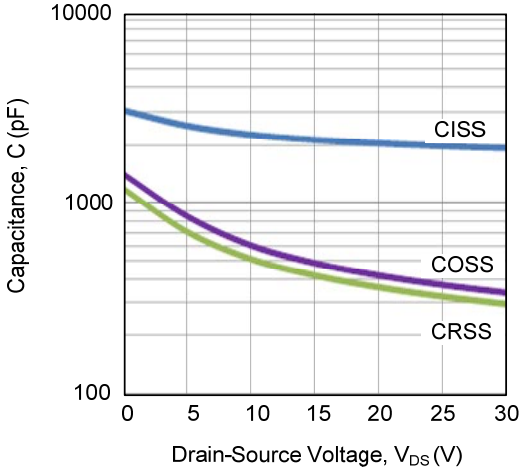
Drain-Source On-Resistance vs. Gate-Source Voltage



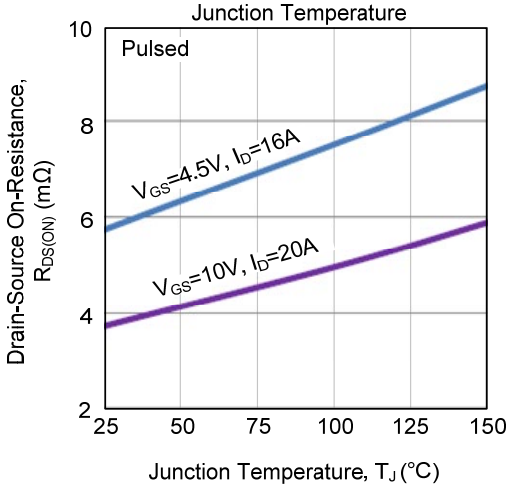
Gate Charge Characteristics



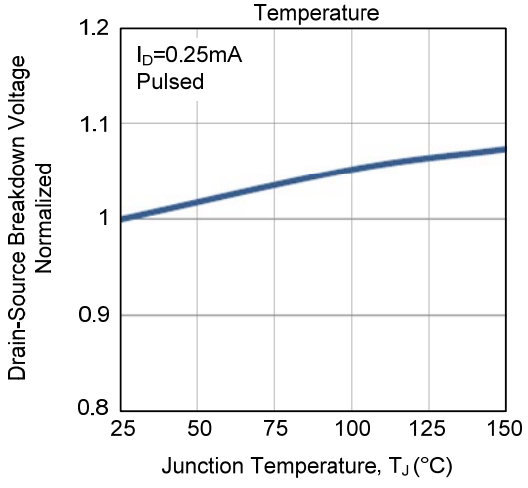
Capacitance Characteristics



Drain-Source On-Resistance vs. Junction Temperature

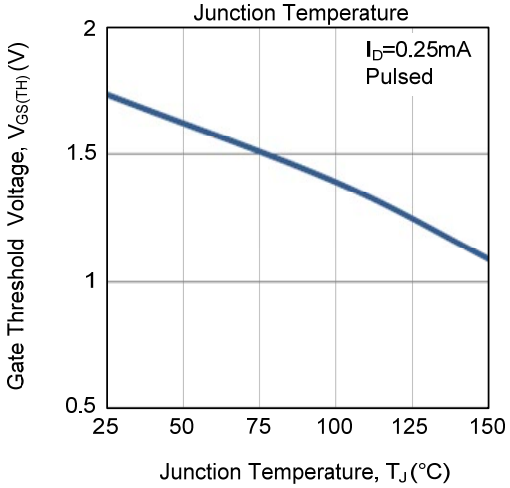


Breakdown Voltage vs. Junction Temperature

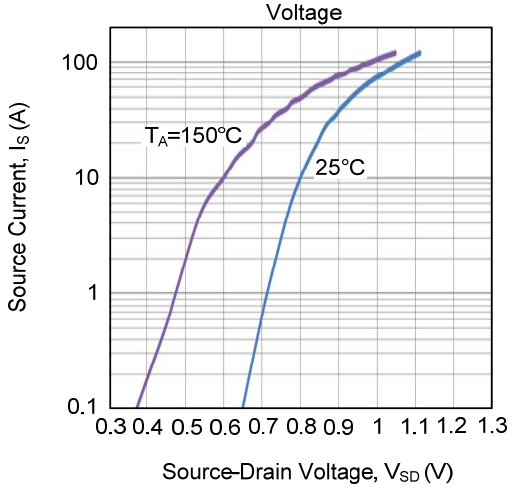


■ TYPICAL CHARACTERISTICS (Cont.)

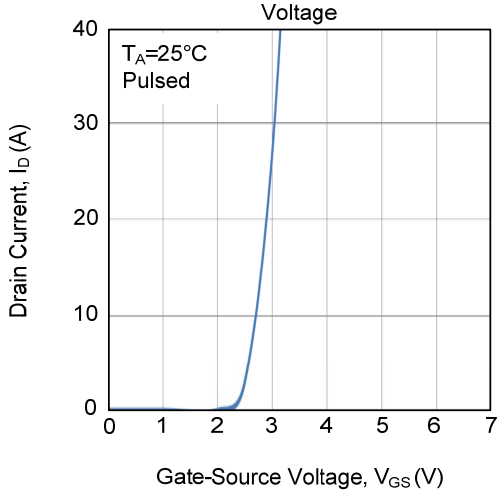
Gate Threshold Voltage vs. Junction Temperature



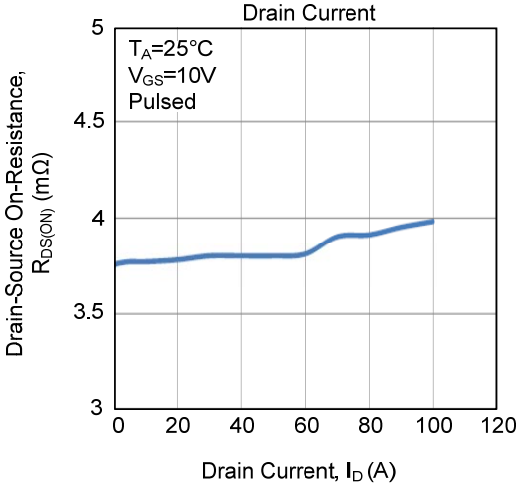
Source Current vs. Source-Drain Voltage



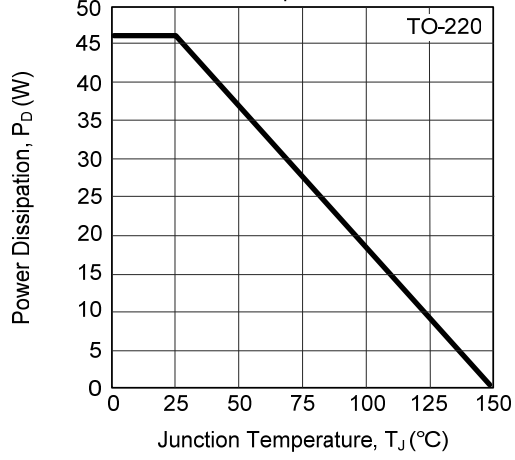
Drain Current vs. Gate-Source Voltage



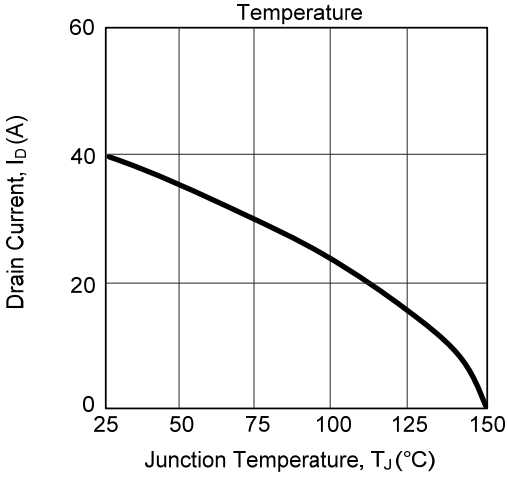
Drain-Source On-Resistance vs. Drain Current



Power Dissipation vs. Junction Temperature



Drain Current vs. Junction Temperature



■ TYPICAL CHARACTERISTICS (Cont.)